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Vishay Siliconix

## N-Channel 100 V (D-S) MOSFET

| PRODUCT             | SUMMARY                            |                    |                       |
|---------------------|------------------------------------|--------------------|-----------------------|
| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω) MAX.       | I <sub>D</sub> (A) | Q <sub>g</sub> (TYP.) |
| 100                 | 0.00610 at V <sub>GS</sub> = 10 V  | 56.6               | 53.5 nC               |
| 100                 | 0.00700 at V <sub>GS</sub> = 7.5 V | 54.4               | 33.3 HC               |

#### Thin-Lead TO-220 FULLPAK



# **Ordering Information:** SUA70060E-E3 (lead (Pb)-free)

#### **FEATURES**

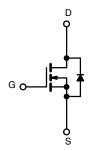
- ThunderFET® power MOSFET
- Q<sub>gd</sub> / Q<sub>gs</sub> ratio < 1 optimizes switching characteristics



- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Power supply
  - Secondary synchronous rectification
  - AC/DC switch-mode power supplies
- DC/DC converter
- Power tools
- · Motor drive switch
- DC/AC inverter



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS                           | (T <sub>C</sub> = 25 °C, unless o | therwise noted)                   |             |      |  |
|--|-----------------------------------|-----------------------------------|-------------|------|--|
| PARAMETER  |                                   | SYMBOL                            | LIMIT       | UNIT |  |
| Drain-Source Voltage                               |                                   | V <sub>DS</sub>                   | 100         | V    |  |
| Gate-Source Voltage                                |                                   | V <sub>GS</sub>                   | ± 20        |      |  |
| Continuous Dusin Coursent /T 150 °C\               | T <sub>C</sub> = 25 °C            |                                   | 56.6        |      |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>C</sub> = 70 °C            | - I <sub>D</sub>                  | 45.2        | Α    |  |
| Pulsed Drain Current (t = 100 μs)                  |                                   | I <sub>DM</sub> 240               |             | ^    |  |
| Avalanche Current                                  |                                   | I <sub>AS</sub>                   | 50          |      |  |
| Single Avalanche Energy <sup>a</sup>               | L = 0.1 mH                        | E <sub>AS</sub>                   | 125         | mJ   |  |
| Maximum Daway Dissination 3                        | T <sub>C</sub> = 25 °C            | Б                                 | 39          | W    |  |
| Maximum Power Dissipation <sup>a</sup>             | T <sub>C</sub> = 70 °C            | - P <sub>D</sub>                  | 25          | VV   |  |
| Operating Junction and Storage Temperature Range   |                                   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C   |  |

| THERMAL RESISTANCE RATINGS                   |                   |       |      |
|--|-------------------|-------|------|
| PARAMETER                                    | SYMBOL            | LIMIT | UNIT |
| Junction-to-Ambient (PCB Mount) <sup>b</sup> | R <sub>thJA</sub> | 60    | °C/W |
| Junction-to-Case (Drain)                     | R <sub>thJC</sub> | 3.2   | C/VV |

#### Notes

- a. Duty cycle  $\leq$  1 %.
- b. When mounted on 1" square PCB (FR4 material).



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| <b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C | C, unless otl   | nerwise noted)   |      |         |         |         |  |
|---|---|--|------|---------|---------|---------|--|
| PARAMETER                                     | SYMBOL  | TEST CONDITIONS  | MIN. | TYP.    | MAX.    | UNIT    |  |
| Static  |   |  |      |         |         |         |  |
| Drain-Source Breakdown Voltage                | $V_{DS}$  | $V_{GS}$ = 0 V, $I_D$ = 250 $\mu A$                                | 100  | -       | -       | V       |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>   | $V_{DS}=V_{GS},I_D=250\;\mu A$                                     | 2    | -       | 4       | V       |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>  | $V_{DS} = 0 V, V_{GS} = \pm 20 V$                                  | -    | -       | ± 100   | nA      |  |
|   |   | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$                     | -    | -       | 1       | 1 μA    |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>  | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_J$ = 125 °C                   | -    | -       | 100     | μΑ      |  |
|   |   | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_J$ = 150 °C                   | -    | -       | 2       | mA      |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>  | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$                   | 50   | -       | -       | Α       |  |
| Drain Course On State Desistance 3            | В   | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$                        | -    | 0.00505 | 0.00610 |         |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>   | $V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$                       | -    | 0.00540 | 0.00700 | Ω       |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>   | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A                      | -    | 85      | -       | S       |  |
| Dynamic <sup>b</sup>                          |   |  |      |         |         |         |  |
| Input Capacitance                             | C <sub>iss</sub>  |  | -    | 3300    | -       |         |  |
| Output Capacitance                            | C <sub>oss</sub>  | $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$   | -    | 1395    | -       | pF      |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>  |  | - 95 | 95      | -       | ]       |  |
| Total Gate Charge <sup>c</sup>                | $Q_g$   |  | -    | 53.5    | 81      |         |  |
| Gate-Source Charge <sup>c</sup>               | Q <sub>gs</sub>   | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$ | -    | 14.5    | -       | nC      |  |
| Gate-Drain Charge <sup>c</sup>                | $Q_{gd}$  |  | -    | 13.2    | -       |         |  |
| Gate Resistance                               | $R_g$   | f = 1 MHz  | 0.9  | 1.9     | 3.8     | Ω       |  |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>  |  | -    | 13      | 26      |         |  |
| Rise Time <sup>c</sup>                        | $\begin{array}{c c} Q_{gs} & V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 30 \text{ A} & - \\ Q_{gd} & - \\ R_g & f = 1 \text{ MHz} & 0.8 \\ \hline t_{d(on)} & - \\ \hline t_r & V_{DD} = 50 \text{ V}, R_L = 1.67 \Omega & - \\ \hline t_{d(off)} & I_D \cong 30 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega & - \\ \end{array}$ | -  | 22   | 44      |         |         |  |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>   | $I_D\cong 30~A,~V_{GEN}=10~V,~R_g=1~\Omega$                        | -    | 27      | 54      | ns<br>- |  |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>  |  | -    | 9       | 18      |         |  |
| Drain-Source Body Diode Ratings a             | nd Characteri   | stics <sup>b</sup> (T <sub>C</sub> = 25 °C)                        |      |         |         |         |  |
| Pulsed Current (t = 100 μs)                   | I <sub>SM</sub>   |  | -    | -       | 240     | Α       |  |
| Forward Voltage <sup>a</sup>                  | V <sub>SD</sub>   | I <sub>F</sub> = 30 A, V <sub>GS</sub> = 0 V                       | -    | 0.86    | 1.4     | V       |  |
| Reverse Recovery Time                         | t <sub>rr</sub>   |  | -    | 88      | 178     | ns      |  |
| Peak Reverse Recovery Charge                  | I <sub>RM(REC)</sub>  | $I_F = 30 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$    | -    | 5       | 10      | Α       |  |
| Reverse Recovery Charge                       | Q <sub>rr</sub>   |  | -    | 220     | 440     | nC      |  |

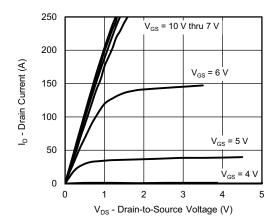
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

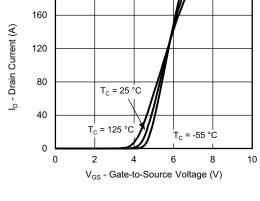
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

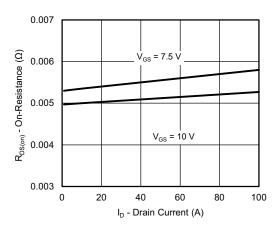


#### **Output Characteristics**

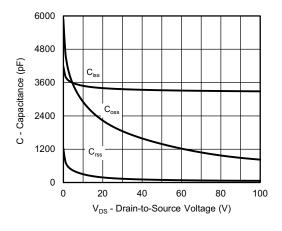


200

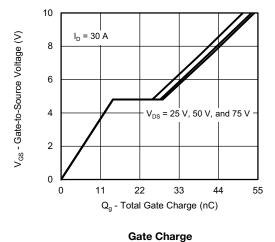
**Transfer Characteristics** 

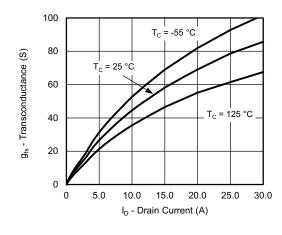


On-Resistance vs. Drain Current



Capacitance

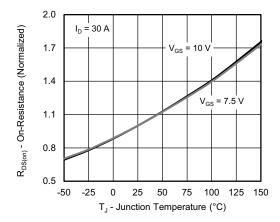




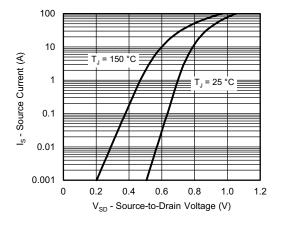
Transconductance



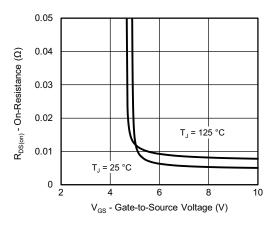
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



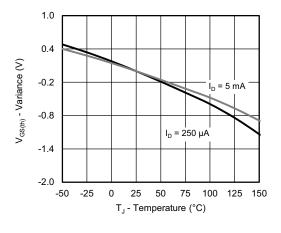
On-Resistance vs. Junction Temperature



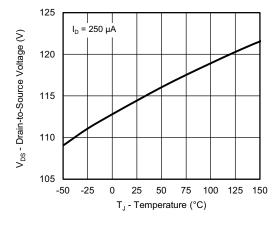
**Source Drain Diode Forward Voltage** 



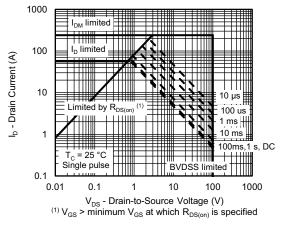
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



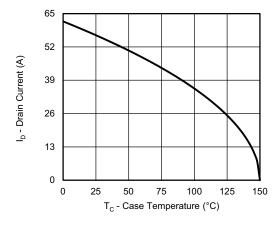
**Drain Source Voltage vs. Junction Temperature** 

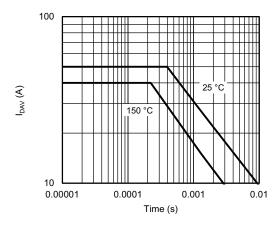


Safe Operating Area



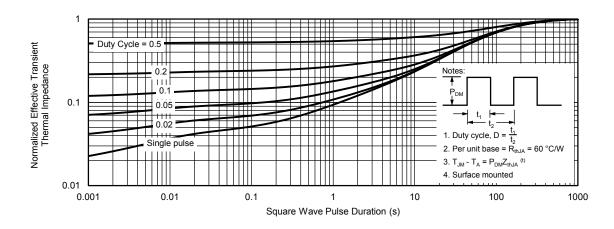
### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)





**Current De-Rating** 

I<sub>DAV</sub> vs. Time



#### Normalized Thermal Transient Impedance, Junction-to-Ambient

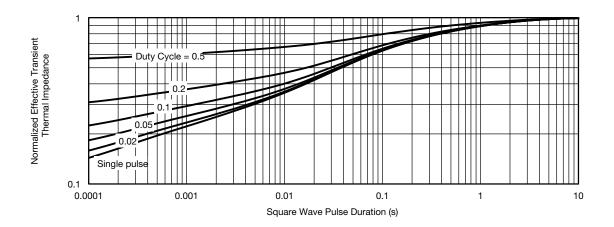
#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

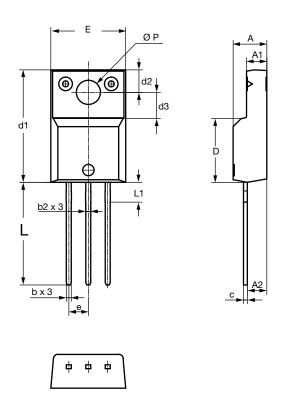


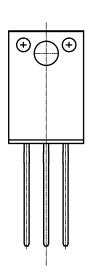
Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220 FULLPAK Thin Lead**





| SYMBOL | DIMENSIONS  |       |       |       |
|--------|-------------|-------|-------|-------|
|        | MILLIMETERS |       | INCI  | HES   |
|        | MIN.        | MAX.  | MIN.  | MAX.  |
| Α      | 4.30        | 4.70  | 0.169 | 0.185 |
| A1     | 2.50        | 2.90  | 0.098 | 0.114 |
| A2     | 2.40        | 2.80  | 0.094 | 0.110 |
| b      | 0.60        | 0.80  | 0.024 | 0.031 |
| b2     | 0.60        | 0.90  | 0.024 | 0.035 |
| С      | -           | 0.60  | -     | 0.024 |
| D      | 8.30        | 8.70  | 0.327 | 0.342 |
| d1     | 14.70       | 15.30 | 0.579 | 0.602 |
| d2     | 2.90        | 3.10  | 0.114 | 0.122 |
| d3     | 3.30        | 3.70  | 0.130 | 0.146 |
| E      | 9.70        | 10.30 | 0.382 | 0.406 |
| е      | 2.50        | 2.70  | 0.098 | 0.106 |
| L      | 13.40       | 13.80 | 0.528 | 0.543 |
| L1     | 1.00        | 2.80  | 0.039 | 0.110 |
| ØP     | 3.00        | 3.40  | 0.118 | 0.134 |

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DWG: 6021

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